

8755 W. Higgins Road Suite 500 Chicago, Illinois USA 60631

April 16th, 2024

RE: PCN # ESU270-91- New Wafer Foundry approval for SP1012-05WTG

To our valued customer,

Littelfuse would like to notify you that we are going to add a new wafer foundry for SP1012-05WTG due to current wafer fab unavailability. There are no changes to fit, form, and function of finished product.

The affected product will be fully qualified in accordance with established performance and reliability criteria. Samples would be provided upon your request.

Form, fit, function changes: None Part number changes: None

Effective date: April 26th, 2024 or sooner

Replacement products: N/A

Last time buy: N/A

This PCN is for your information and acknowledgement. If you have any other questions or concerns, please contact your local sales team or product team below for further assistance.

We value your business and look forward to assisting you whenever possible.

Best Regards,

Sophia Hu TVS Diode Array Assistant Product Manager Semiconductor Business Unit, Wuxi, China +86 510 85277701 - 7653 shu@littelfuse.com



800 E. Northwest Highway Des Plaines, IL 60016

# Product/Process Change Notice (PCN)

PCN#:		Contact Information				
ESU270-91 Date: April 26th, 2024.		Name : Sophia Hu				
Product Identification:		Title : Assistant Product Marketing Manager				
Additional wafer foundry approval for SP1012-05WTG.		Phone #: +86 13771377277				
Implementation Date for Change:		Fax# : N/A				
April 26 <sup>th</sup> , 2024 or sooner		E-mail : shu@littelfuse.com				
	Description					
Category of Change:	Description of Change:					
☐ Assembly Process ☐ Data Sheet	Additional wafer foundry approved for SP1012-05WTG SPA™ TVS Diode Arrays products. There are no changes to fit, form, function of the finished product.					
☐ Technology						
Discontinuance/Obsolescence						
□ Equipment						
□ Raw Material						
☐ Testing						
☐ Fabrication Process						
☐ Other:						
Important Dates:						
☐ Final Qualification Data Available: Upon request						
☐ Date of Final Product Shipment:						
Method of Distinguishing Changed Product						
☐ Product Mark,						
□ Date Code,						
Other, Littelfuse internal work order documentation						
Demonstrated or Anticipated Impact on Form, Fit, Function or Reliability:						
N/A						
LF Qualification Plan/Results:						
Yes						
Customer Acknowledgement of Receipt: Littelfuse requests you acknowledge receipt of this PCN. In your acknowledgement, you can						
grant approval or request additional information. Littelfuse will assume the change is acceptable if no acknowledgement is received within 30 days						
of this notice. Lack of any additional response within 90 days of PCN issuance further constitutes acceptance of the change.						



# PCN Report ETR # Various

Prepared By: Light Hsieh-Product Engineering Manager, Raider Chen-Product Engineer,

Sophia Hu- Assistant Product Manager

**Date** : 2024/4/11

Device : SP1012-05WTG

Revision : A

#### 1.0 Objective:

Qualify a new wafer foundry for SP1012-05WTG. Summarize the physical items, electrical characteristics, and reliability results of qualification lots.

#### 2.0 Applicable Devices:

2.1 Product name: SP1012-05WTG

#### 3.0 Assembly, Process & Material Differences/Changes:

#### 3.1 Assembly Changes:

No change of assemble process.

#### 3.2 Process Changes:

No change of process method.

#### 3.3 Material Change:

Wafer change.

#### 4.0 Packing Method

No change of packing method.

#### 5.0 Physical Differences/Changes:

No change of physical.

#### 6.0 Reliability Test Results Summary:

6.1 Reliability summary report:

Test Items	Condition	S/S	Results	ETR#
Pre-conditioning (PC)	JESD22-A113	77 each lot	0/231	TR24-04-007977 TR24-04-007978 TR24-04-007979
DC Blocking (HTRB)	Bias = VRWM, Ta = 150°C, Duration = 504 Hours	77 each lot	0/231	
Temperature Cycle (TC)	Ta = -55°C to 150°C, Duration = 500 Cycles	77 each lot	0/231	
Solderability (SD)	ANSI-J-STD-002	10 each lot	0/70	

## 7.0 Electrical Characteristic Summary:

Electrical performances were comparable and characterization data is available upon request.

#### 8.0 Changed Part Identification:

Identified by date code.

## 9.0 Approvals:

Sophia Hu

Light Hsieh SPA Assistant Product Manager SPA Product Engineering Manager SPA Product Engineer Littelfuse, Wuxi Littelfuse, HsinChu Littelfuse, HsinChu

**Raider Chen**